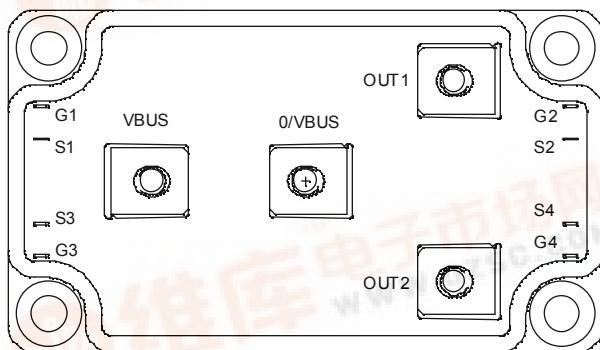
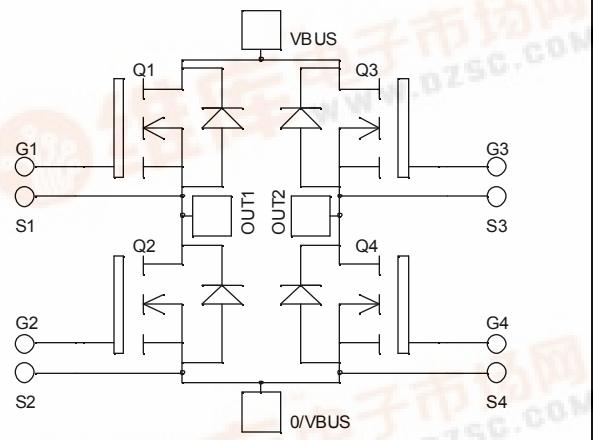




# APTM120H29FG

## Full - Bridge MOSFET Power Module

$V_{DSS} = 1200V$   
 $R_{DSon} = 290m\Omega$  typ @  $T_j = 25^\circ C$   
 $I_D = 34A$  @  $T_c = 25^\circ C$



### Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
$V_{DSS}$	Drain - Source Breakdown Voltage	1200	V
$I_D$	Continuous Drain Current	$T_c = 25^\circ C$	A
		$T_c = 80^\circ C$	
$I_{DM}$	Pulsed Drain current	136	
$V_{GS}$	Gate - Source Voltage	$\pm 30$	V
$R_{DSon}$	Drain - Source ON Resistance	348	$m\Omega$
$P_D$	Maximum Power Dissipation	$T_c = 25^\circ C$	W
		$T_c = 80^\circ C$	
$I_{AR}$	Avalanche current (repetitive and non repetitive)	22	A
$E_{AR}$	Repetitive Avalanche Energy	50	$mJ$
$E_{AS}$	Single Pulse Avalanche Energy	3000	

 CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com

All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified

**Electrical Characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}, V_{DS} = 1200\text{V}$	$T_j = 25^\circ\text{C}$		350	$\mu\text{A}$
		$V_{GS} = 0\text{V}, V_{DS} = 1000\text{V}$	$T_j = 125^\circ\text{C}$		1500	
$R_{DS(on)}$	Drain – Source on Resistance	$V_{GS} = 10\text{V}, I_D = 17\text{A}$		290	348	$\text{m}\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 5\text{mA}$	3		5	$\text{V}$
$I_{GSS}$	Gate – Source Leakage Current	$V_{GS} = \pm 30\text{ V}, V_{DS} = 0\text{V}$			$\pm 150$	$\text{nA}$

**Dynamic Characteristics**

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{V}$ $V_{DS} = 25\text{V}$ $f = 1\text{MHz}$		10.3		$\text{nF}$
$C_{oss}$	Output Capacitance			1.54		
$C_{rss}$	Reverse Transfer Capacitance			0.26		
$Q_g$	Total gate Charge	$V_{GS} = 10\text{V}$ $V_{Bus} = 600\text{V}$ $I_D = 34\text{A}$		374		$\text{nC}$
$Q_{gs}$	Gate – Source Charge			48		
$Q_{gd}$	Gate – Drain Charge			240		
$T_{d(on)}$	Turn-on Delay Time		20			$\text{ns}$
$T_r$	Rise Time	$V_{GS} = 15\text{V}$ $V_{Bus} = 800\text{V}$ $I_D = 34\text{A}$	15			
$T_{d(off)}$	Turn-off Delay Time		160			
$T_f$	Fall Time		45			
$E_{on}$	Turn-on Switching Energy	<b>Inductive switching @ 25°C</b> $V_{GS} = 15\text{V}, V_{Bus} = 800\text{V}$ $I_D = 34\text{A}, R_G = 2.5\Omega$		1980		$\mu\text{J}$
$E_{off}$	Turn-off Switching Energy			1371		
$E_{on}$	Turn-on Switching Energy	<b>Inductive switching @ 125°C</b> $V_{GS} = 15\text{V}, V_{Bus} = 800\text{V}$ $I_D = 34\text{A}, R_G = 2.5\Omega$		3131		$\mu\text{J}$
$E_{off}$	Turn-off Switching Energy			1714		

**Source - Drain diode ratings and characteristics**

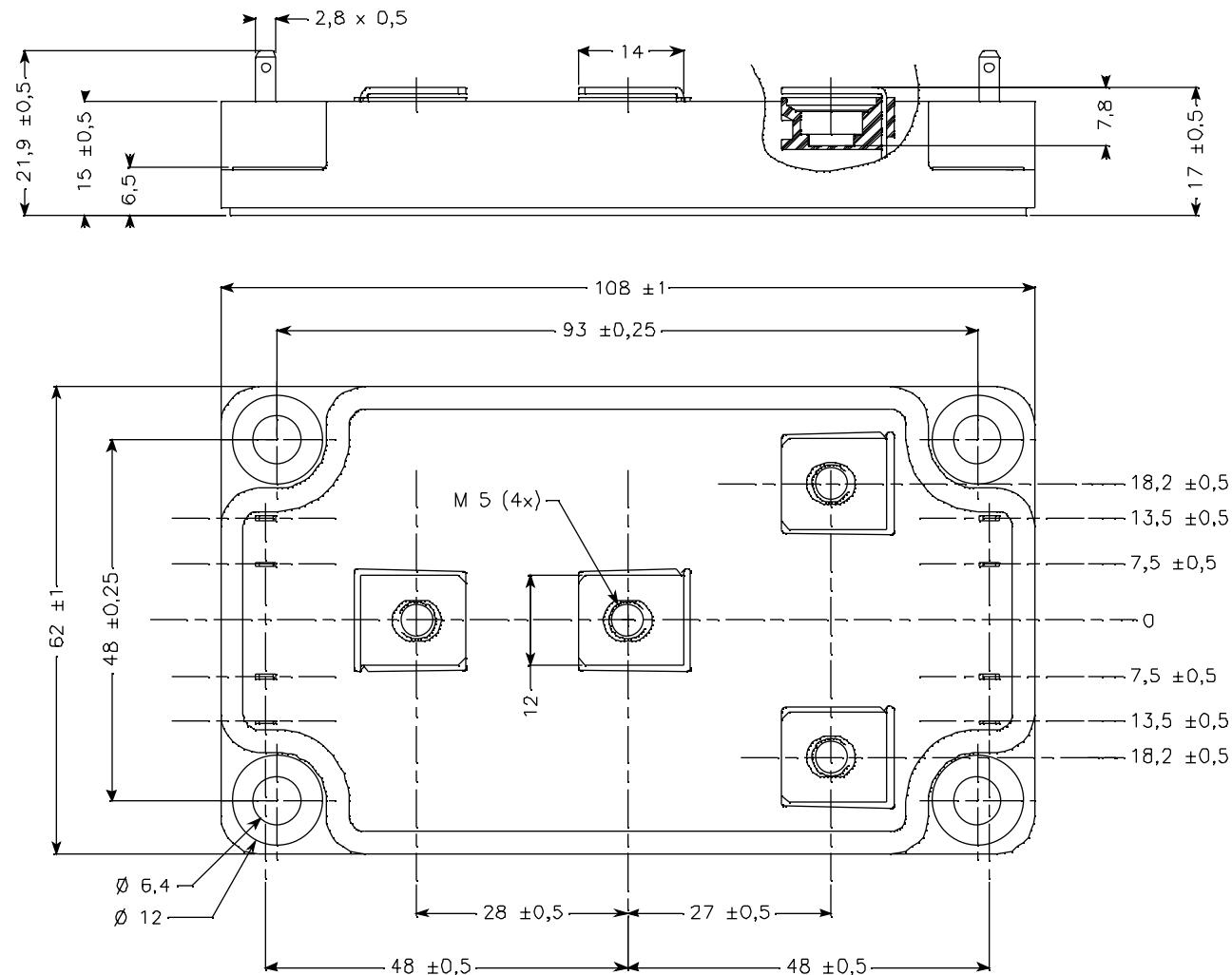
Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
$I_S$	Continuous Source current (Body diode)		$T_c = 25^\circ\text{C}$		34	$\text{A}$
			$T_c = 80^\circ\text{C}$		25	
$V_{SD}$	Diode Forward Voltage	$V_{GS} = 0\text{V}, I_S = - 34\text{A}$			1.3	$\text{V}$
$dv/dt$	Peak Diode Recovery ①				18	$\text{V/ns}$
$t_{rr}$	Reverse Recovery Time	$I_S = - 34\text{A}$ $V_R = 600\text{V}$ $dI/dt = 200\text{A}/\mu\text{s}$	$T_j = 25^\circ\text{C}$		320	$\text{ns}$
			$T_j = 125^\circ\text{C}$		650	
$Q_{rr}$	Reverse Recovery Charge		$T_j = 25^\circ\text{C}$	4		$\mu\text{C}$
			$T_j = 125^\circ\text{C}$	14		

① dv/dt numbers reflect the limitations of the circuit rather than the device itself.

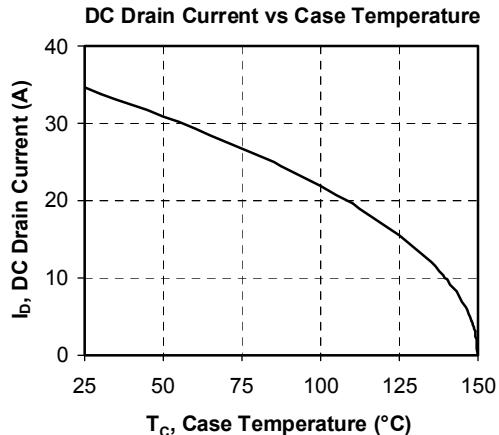
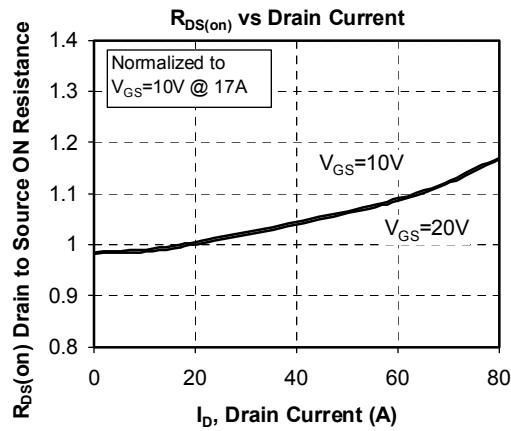
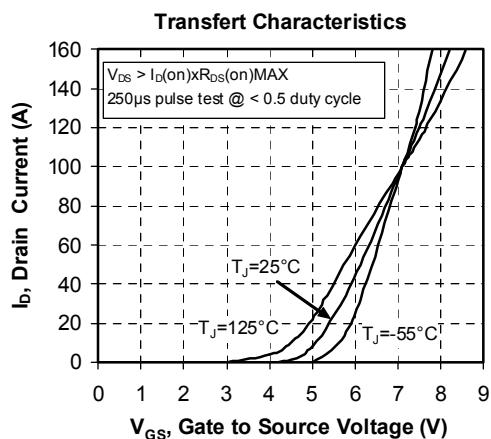
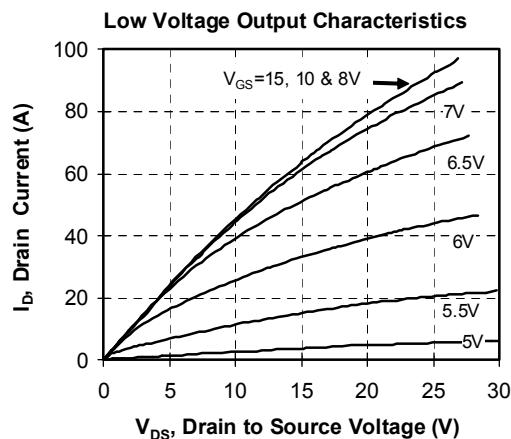
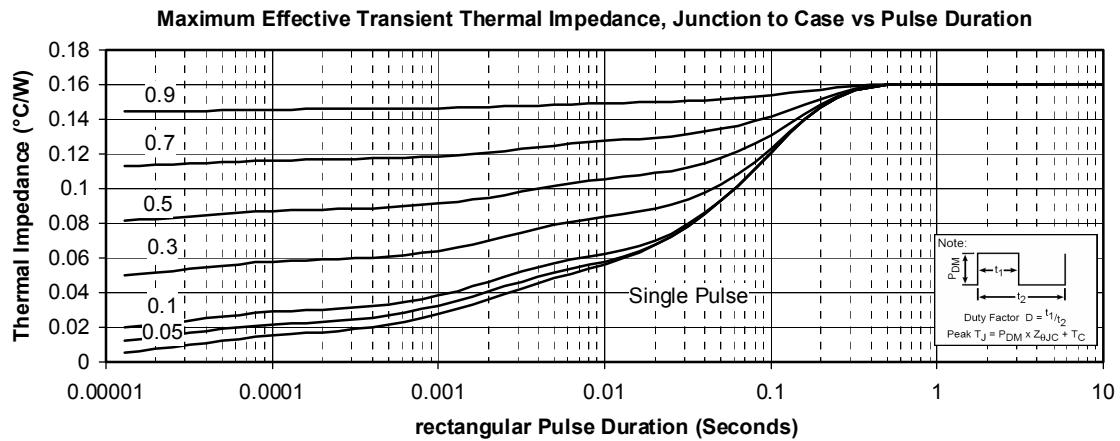
 $I_S \leq - 34\text{A}$     $di/dt \leq 700\text{A}/\mu\text{s}$     $V_R \leq V_{DSS}$     $T_j \leq 150^\circ\text{C}$

**Thermal and package characteristics**

Symbol	Characteristic		Min	Typ	Max	Unit
$R_{thJC}$	Junction to Case Thermal Resistance				0.16	°C/W
$V_{ISOL}$	RMS Isolation Voltage, any terminal to case t = 1 min, $I_{isol} < 1\text{mA}$ , 50/60Hz	2500				V
$T_J$	Operating junction temperature range	-40		150		
$T_{STG}$	Storage Temperature Range	-40		125		°C
$T_C$	Operating Case Temperature	-40		100		
Torque	Mounting torque	To heatsink For terminals	M6 M5	3 2	5 3.5	N.m
Wt	Package Weight				280	g

**SP6 Package outline (dimensions in mm)**

 See application note APT0601 - Mounting Instructions for SP6 Power Modules on [www.microsemi.com](http://www.microsemi.com)

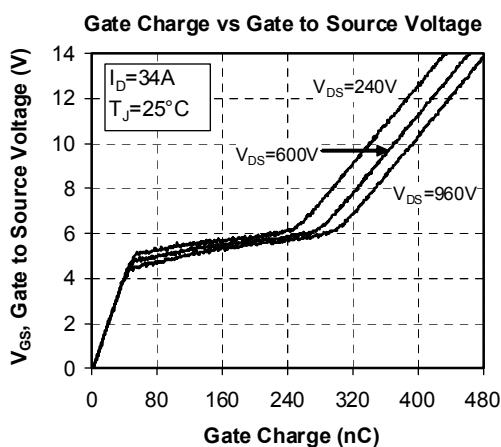
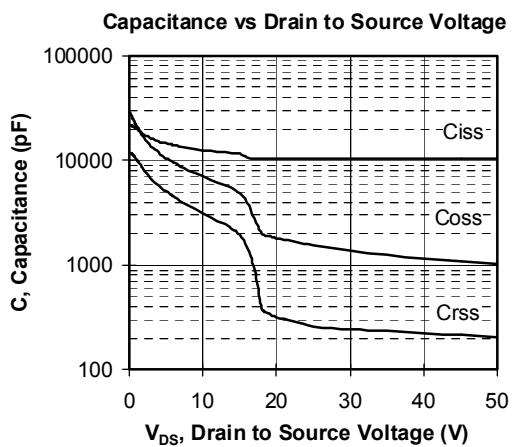
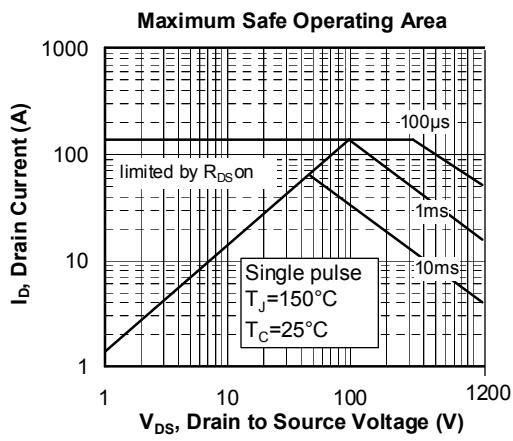
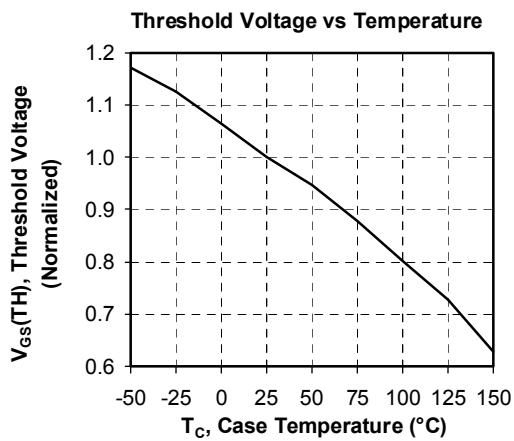
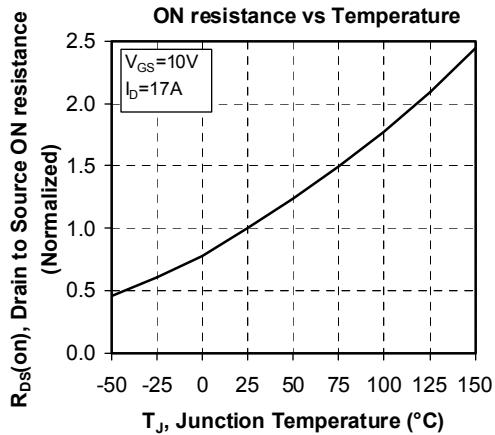
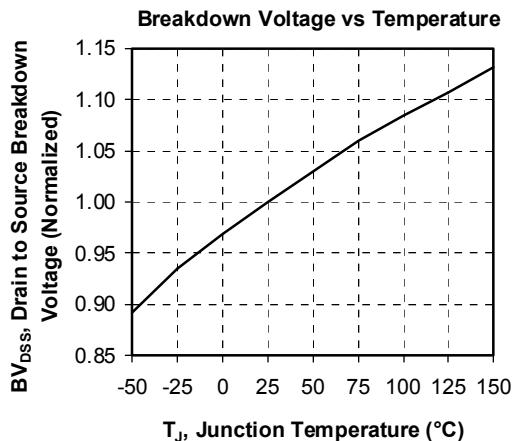
### Typical Performance Curve





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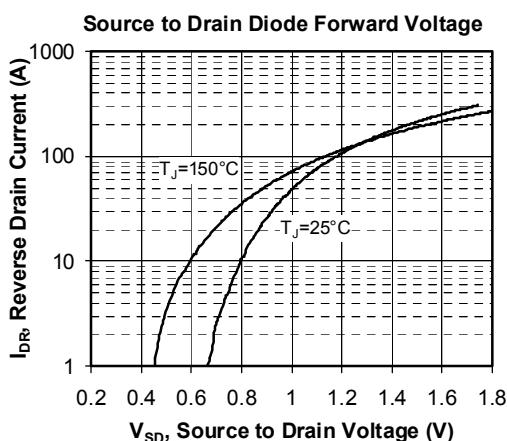
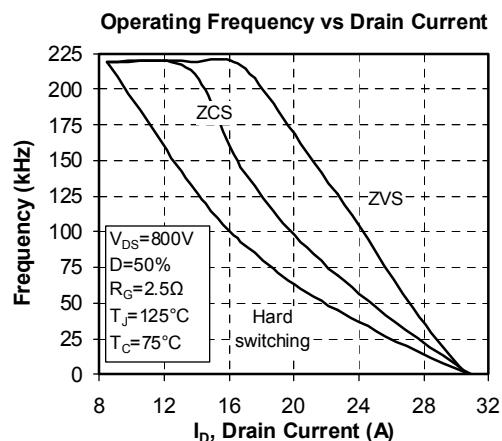
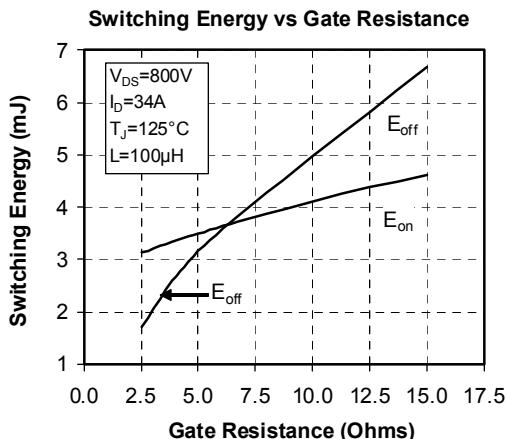
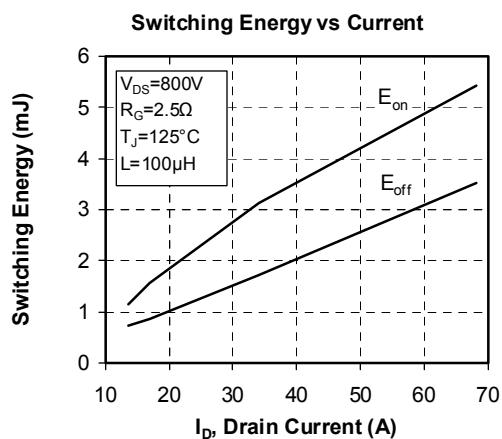
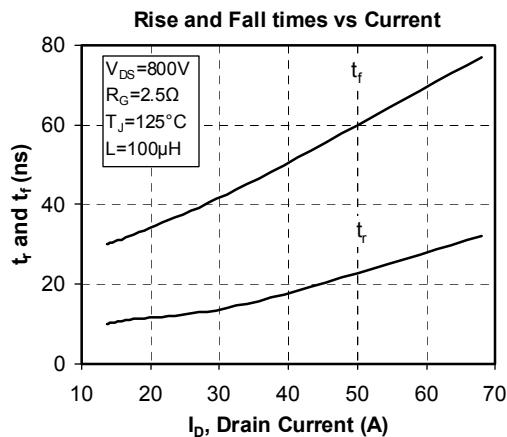
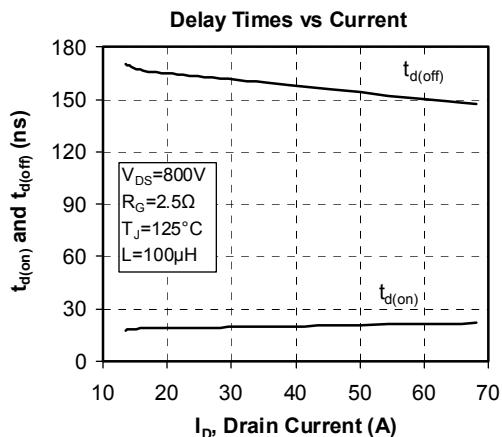
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Microsemi's products are covered by one or more of U.S patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. U.S and Foreign patents pending. All Rights Reserved.